

# Product Document



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# AS1113

## 50mA, 16-Channel LED Driver with Diagnostics

### 1 General Description

The AS1113 is designed to drive up to 16 LEDs through a fast serial interface and features 16 output constant current drivers and an on-chip diagnostic read-back function.

The high clock-frequency (up to 50MHz), adjustable output current, and flexible serial interface makes the device perfectly suited for high-volume transmission applications.

Output current is adjustable (up to 50mA/channel) using an external resistor (REXT).

The serial interface with Schmitt trigger inputs includes an integrated shift register. Additionally, an internal data register stores the currently displayed data.

The device features integrated diagnostics for over-temperature, open-LED, and shorted-LED conditions. Integrated registers store global fault status information during load as well as the detailed temperature/open-LED/shorted-LED diagnostics results.

The AS1113 also features a low-current diagnostic mode to minimize display flicker during fault testing.

The AS1113 is available in a 24-pin SSOP and the 28-pin QFN (5x5mm) package.

If a higher output current is needed, please see the AS1110 with 100mA drive capability.

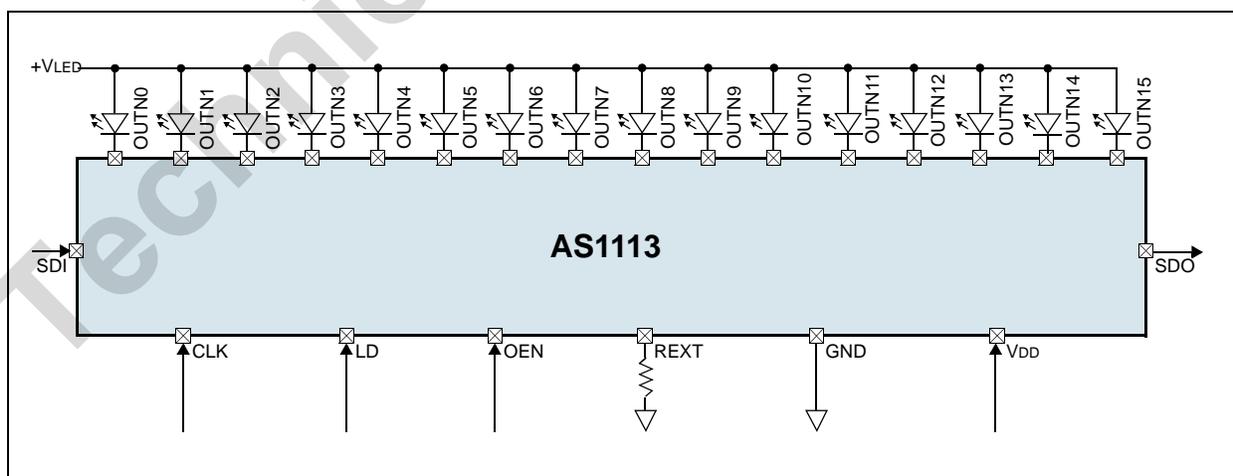
### 2 Key Features

- 16 Constant-Current Output Channels
- Excellent Output Current Accuracy
  - Between Channels:  $<\pm 3\%$
  - Between Devices:  $<\pm 6\%$
- Output Current Per Channel: 0.5 to 50mA
- Controlled In-Rush Current
- Over-Temperature, Open-LED, Shorted-LED Diagnostic Functions
- Low-Current Test Mode
- Global Fault Monitoring
- Low Shutdown Mode Current: 10 $\mu$ A
- Fast Serial Interface: 50MHz
- Cascaded Configuration
- Extremely Fast Output Drivers Suitable for PWM
- 24-pin SSOP and 28-pin QFN (5x5mm) Package

### 3 Applications

The device is ideal for fixed- or slow-rolling displays using static or multiplexed LED matrix and dimming functions, large LED matrix displays, mixed LED display and switch monitoring, displays in elevators, public transports (underground, trains, buses, taxis, airplanes, etc.), large displays in stadiums and public areas, price indicators in retail stores, promotional panels, bar-graph displays, industrial controller displays, white good panels, emergency light indicators, and traffic signs.

Figure 1. Main Diagram and Pin Assignments



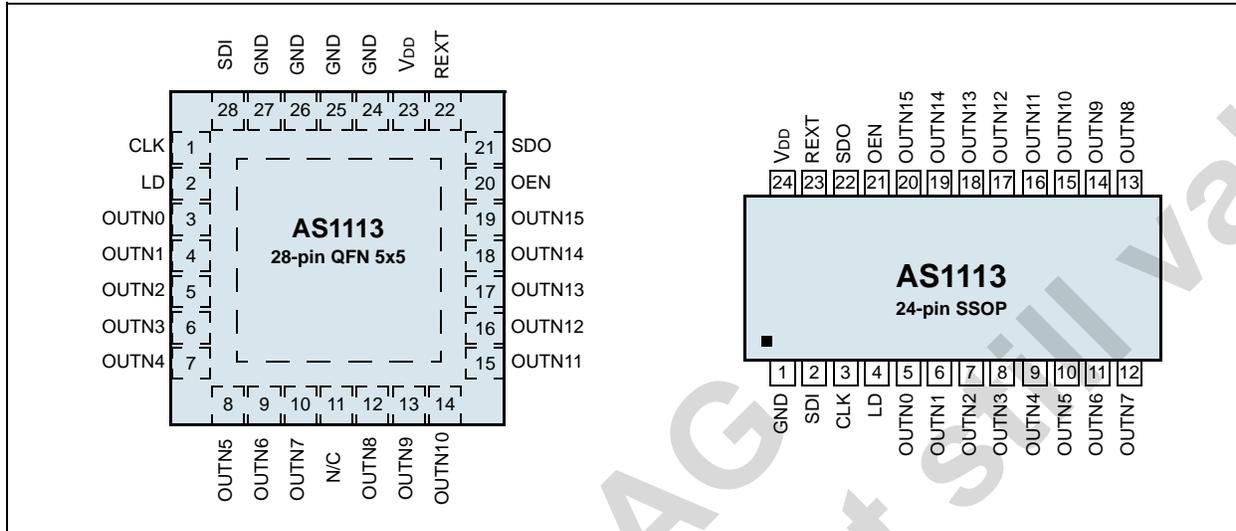
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## 4 Pinout

### Pin Assignments

Figure 2. Pin Assignments (Top View)



### Pin Descriptions

Table 1. Pin Descriptions

Pin Number		Pin Name	Description
SSOP	QFN		
1	24:27	GND	<b>Ground</b>
2	28	SDI	<b>Serial Data Input</b>
3	1	CLK	<b>Serial Data Clock.</b> The rising edge of the CLK signal is used to clock data into and out of the AS1113 shift register. In error mode, the rising edge of the CLK signal is used to switch error modes.
4	2	LD	<b>Serial Data Load</b>
5:20	3:10 12:19	OUTN0:15	<b>Output Current Drivers.</b> These pins are used as LED drivers or for input sense for diagnostic modes. Data is transferred to the data register at the rising edge of these pins.
21	20	OEN	<b>Output Enable.</b> The active-low pin OEN signal can always enable output drivers to sink current independent of the AS1113 mode. 0 = Output drivers are enabled. 1 = Output drivers are disabled.
22	21	SDO	<b>Serial Data Output.</b> In normal mode SDO is latched out 8.5 clock cycles after SDI is latched in. In global error detection mode this pin indicates the occurrence of a global error. 0 = Global error mode returned an error. 1 = No errors.
23	22	REXT	<b>External Resistor Connection.</b> This pin connects through the external resistor (REXT) to GND, to setup the load current.
24	23	VDD	<b>Positive Supply Voltage</b>
-	11	N/C	<b>Not connected</b>

## 5 Absolute Maximum Ratings

Stresses beyond those listed in [Table 2](#) may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in [Section 6 Electrical Characteristics on page 5](#) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter		Min	Max	Units	Comments
V <sub>DD</sub> to GND		0	7	V	
Input Voltage		-0.4	V <sub>DD</sub> +0.4	V	
Output Voltage		-0.4	15	V	
GND Pin Current			1000	mA	
Thermal Resistance $\Theta_{JA}$			88	°C/W	on PCB, 24-pin SSOP package
			23	°C/W	on PCB, 28-pin QFN (5x5mm) package
Ambient Temperature		-40	+85	°C	
Storage Temperature		-55	150	°C	
Humidity		5	86	%	Non-condensing
Electrostatic Discharge	Digital Outputs	2		kV	Norm: MIL 833 E method 3015
	All Other Pins	2			
Latch-Up Immunity		-100 - (I <sub>NOM</sub> x 0.5)	+100 + I <sub>NOM</sub>	mA	EIA/JESD78
Package Body Temperature			+260	°C	The reflow peak soldering temperature (body temperature) specified is in accordance with IPC/JEDEC J-STD-020D "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices". The lead finish for Pb-free leaded packages is matte tin (100% Sn).

## 6 Electrical Characteristics

$V_{DD} = +3.0V$  to  $+5.5V$ ,  $T_{AMB} = -40^{\circ}C$  to  $+85^{\circ}C$  (unless otherwise specified).

Table 3. Electrical Characteristics

Symbol	Parameter		Condition	Min	Typ	Max	Unit
V <sub>DD</sub>	Supply Voltage			3.0		5.5	V
V <sub>DS</sub>	Output Voltage		OUTN0:15	0		15.0	V
I <sub>OUT</sub>	Output Current		OUTN0:15	0.5		50	mA
I <sub>OH</sub>			SDO	-1.0			
I <sub>OL</sub>			SDO	1.0			
V <sub>IH</sub>	Input Voltage	High Level	CLK, OEN, LD, SDI	$0.7 \times V_{DD}$		$V_{DD} + 0.3$	V
V <sub>IL</sub>		Low Level		-0.3		$0.3 \times V_{DD}$	
I <sub>DS(OFF)</sub>	Output Leakage Current		OEN = 1, V <sub>DS</sub> = 15.0V			0.5	μA
V <sub>OL</sub>	Output Voltage	SDO	I <sub>OL</sub> = +1.0mA			0.4	V
V <sub>OH</sub>			I <sub>OH</sub> = -1.0mA	$V_{DD} - 0.4V$			
I <sub>AV(LC1)</sub>	Device-to-Device Average Output Current from OUTN0 to OUTN15		V <sub>DS</sub> = 0.5V, V <sub>DD</sub> = Const., R <sub>EXT</sub> = 744Ω		25.25		mA
ΔI <sub>AV(LC1)</sub>	Current Skew (Between Channels)		V <sub>DS</sub> ≥ 0.5V, V <sub>DD</sub> = Const., R <sub>EXT</sub> = 744Ω		±1.5	±3	%
I <sub>AV(LC2)</sub>	Device-to-Device Average Output Current from OUTN0 to OUTN15		V <sub>DS</sub> = 0.6V, V <sub>DD</sub> > 3.3V, R <sub>EXT</sub> = 372Ω		50.5		mA
ΔI <sub>AV(LC2)</sub>	Current Skew (Between Channels)		V <sub>DS</sub> ≥ 0.6V, V <sub>DD</sub> = Const., R <sub>EXT</sub> = 372Ω		±1.5	±3	%
I <sub>LC</sub>	Low-Current Diagnosis Mode		V <sub>DS</sub> = 0.8V, V <sub>DD</sub> = 5.0V	0.4	0.6	0.8	mA
I <sub>PD</sub>	Power Down Supply Current		V <sub>DS</sub> = 0.8V, V <sub>DD</sub> = 5.0V, R <sub>EXT</sub> = 372Ω, OUTN0:15 = On		10	20	μA
%/ΔV <sub>DS</sub>	Output Current vs. Output Voltage Regulation		V <sub>DS</sub> within 1.0 and 3.0V		±0.1		%/V
%/ΔV <sub>DD</sub>	Output Current vs. Supply Voltage Regulation		V <sub>DD</sub> within 3.0 and 5.0V		±1		%/V
R <sub>IN(UP)</sub>	Pullup Resistance		OEN	250	500	800	kΩ
R <sub>IN(DOWN)</sub>	Pulldown Resistance		LD	250	500	800	kΩ
V <sub>THL</sub>	Error Detection Threshold Voltage			0.25	0.3	0.45	V
V <sub>THH</sub>	Error Detection Threshold Voltage		V <sub>DD</sub> = 3.0V	1.2	1.3	1.4	V
			V <sub>DD</sub> = 5.0V	2.0	2.2	2.4	
T <sub>OV1</sub>	Overtemperature Threshold Flag				150		°C
I <sub>DD(OFF)0</sub>	Supply Current	Off	R <sub>EXT</sub> = Open, OUTN0:15 = Off		2.7	6	mA
I <sub>DD(OFF)1</sub>			R <sub>EXT</sub> = 744Ω, OUTN0:15 = Off		4.3	8	
I <sub>DD(OFF)2</sub>			R <sub>EXT</sub> = 372Ω, OUTN0:15 = Off		5.4	9	
I <sub>DD(ON)1</sub>		On	R <sub>EXT</sub> = 744Ω, OUTN0:15 = On		6.2	11	
			R <sub>EXT</sub> = 372Ω, OUTN0:15 = On		10.5	15	

## Switching Characteristics

$V_{DD} = 3.0$  to  $5.5V$ ,  $V_{DS} = 0.8V$ ,  $V_{IH} = V_{DD}$ ,  $V_{IL} = GND$ ,  $R_{EXT} = 372\Omega$ ,  $V_{LOAD} = 4.0V$ ,  $R_{LOAD} = 64\Omega$ ,  $C_{LOAD} = 10pF$ ; guaranteed by design.

Table 4. Switching Characteristics for  $V_{DD} = 5V$

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
tp1	Propagation Delay Time (Without Staggered Output Delay)	CLK - SDO		5	10	ns
tp2		LD - OUTN <sub>n</sub>		100	200	
tp3		OEN - OUTN <sub>n</sub>		100	200	
tp4	Propagation Delay Time				10	ns
tw(CLK)	Pulse Width	CLK	15			ns
tw(L)		LD	15			
tw(OE)		OEN (@I <sub>OUT</sub> < 60mA)	200			
t <sub>R</sub> *	CLK Rise Time				500	ns
t <sub>F</sub> *	CLK Fall Time				500	ns
t <sub>OR</sub>	Output Rise Time of V <sub>OUT</sub> (Turn Off)			100	200	ns
t <sub>OF</sub>	Output Fall Time of V <sub>OUT</sub> (Turn On)			100	300	ns
t <sub>SU(D)</sub>	Setup Time for SDI		5			ns
t <sub>H(D)</sub>	Hold Time for SDI		5			ns
t <sub>SU(L)</sub>	Setup Time for LD		5			ns
t <sub>H(L)</sub>	Hold Time for LD		5			ns
t <sub>TESTING</sub>	OEN Time for Error Detection		2000			ns
t <sub>STAG</sub>	Staggered Output Delay			20	40	ns
t <sub>SU(OE)</sub>	Output Enable Setup Time		20			ns
t <sub>GSW(ERROR)</sub>	Global Error Switching Setup Time		10			ns
t <sub>SU(ERROR)</sub>	Global Error Detection Setup Time		10			ns
t <sub>P(I/O)</sub>	Propagation Delay Global Error Flag				5	ns
t <sub>SW(ERROR)</sub>	Switching Time Global Error Flag				10	ns
f <sub>CLK</sub>	Maximum Clock Frequency (Cascade Operation)		30	50		MHz
t <sub>P3,ON</sub>	Low-Current Test Mode Propagation Delay Time	Turn ON		3	5	μs
t <sub>P3,OFF</sub>		Turn OFF		0.05	0.1	μs
t <sub>REXT2,1</sub>	External Resistor Reaction Time	Change from R <sub>EXT1</sub> = 372Ω, I <sub>OUT1</sub> = 50.52mA to R <sub>EXT2</sub> = 37.2kΩ, I <sub>OUT2</sub> < 1mA		0.5	1	μs
t <sub>REXT2,1</sub>	External Resistor Reaction Time	Change from R <sub>EXT1</sub> = 37.2kΩ, I <sub>OUT1</sub> = 0.5mA to R <sub>EXT2</sub> = 372Ω, I <sub>OUT2</sub> > 25mA		0.5	1	μs

\* If multiple AS1113 devices are cascaded and t<sub>r</sub> or t<sub>f</sub> is large, it may be critical to achieve the timing required for data transfer between two cascaded LED drivers.

## 7 Typical Operating Characteristics

Figure 3. Output Current vs.  $R_{EXT}$ ,  $V_{DD} = 5V$ ;  $V_{DS} = 0.8V$ ,  $T_{AMB} = 25^{\circ}C$

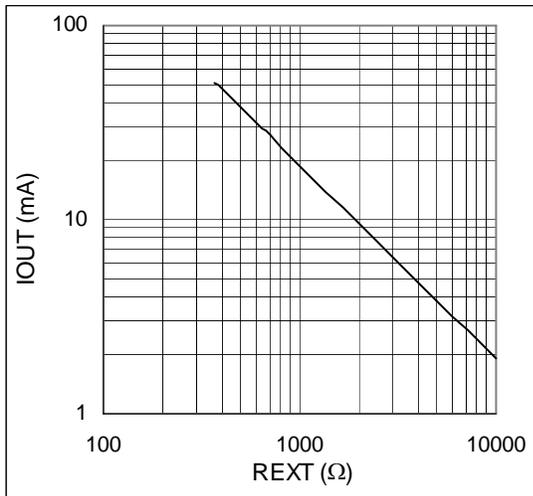


Figure 4. Relative Output Current Error vs.  $V_{DD}$ ,  $I_{OUT}/I_{OUT}@V_{DD}=5V - 1$ ,  $T_{AMB} = 25^{\circ}C$

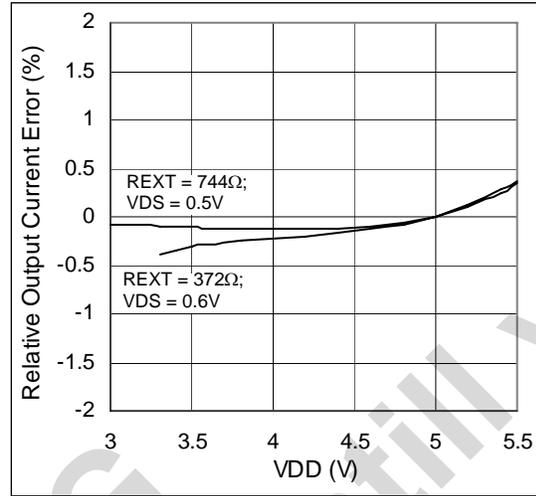


Figure 5. Output Current vs.  $V_{DS}$ ;  $V_{DD} = 5V$ ,  $T_{AMB} = 25^{\circ}C$

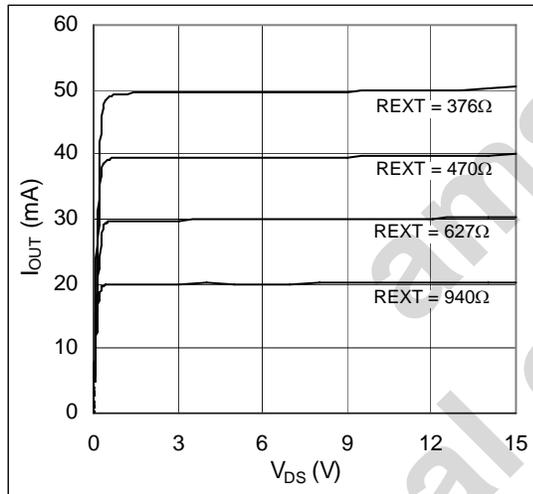
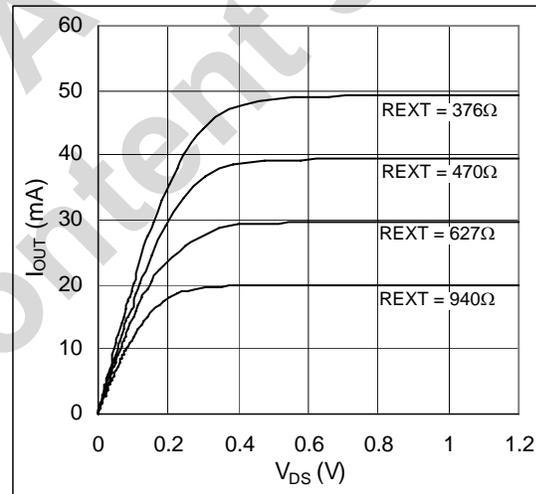


Figure 6. Output Current vs.  $V_{DS}$ ;  $V_{DD} = 5V$ ,  $T_{AMB} = 25^{\circ}C$



## 8 Detailed Description

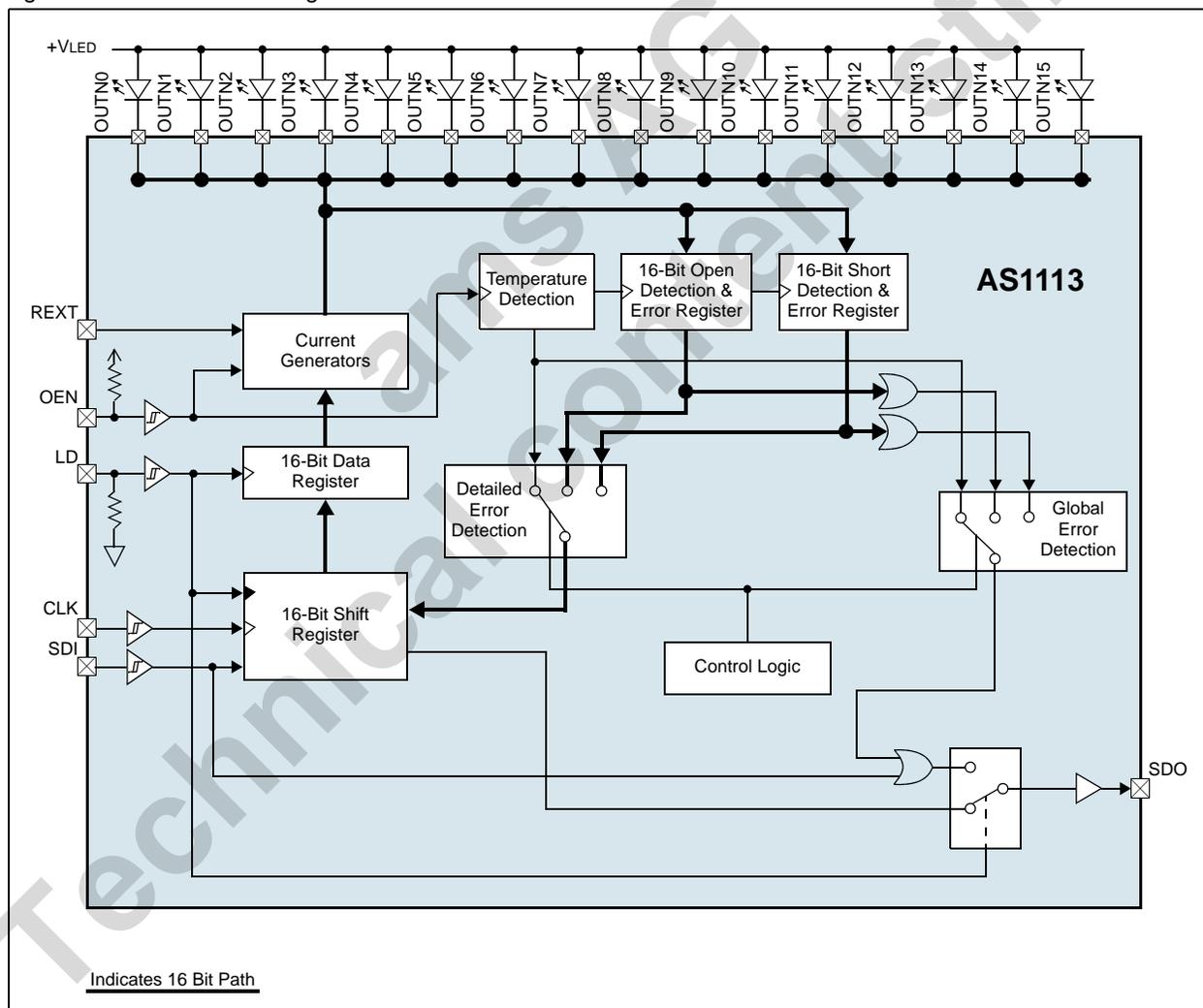
The AS1113 is designed to drive up to 16 LEDs through a fast serial interface and 16 constant-current output drivers. Furthermore, the AS1113 provides diagnostics for detecting open- or shorted-LEDs, as well as over-temperature conditions for LED display systems, especially LED traffic sign applications.

The AS1113 contains an 16-bit shift register and an 16-bit data register, which convert serial input data into parallel output format. At AS1113 output stages, sixteen regulated current sinks are designed to provide uniform and constant current with excellent matching between ports for driving LEDs within a wide range of forward voltage variations. External output current is adjustable from 0.5 to 50mA using an external resistor for flexibility in controlling the brightness intensity of LEDs. The AS1113 guarantees to endure 15V maximum at the outputs.

The serial interface is capable of operating at a minimum of 30 MHz, satisfying the requirements of high-volume data transmission.

Using a multiplexed input/output technique, the AS1113 adds additional functionality to pins SDO, LD and OEN. These pins provide highly useful functions (open- and shorted-LED detection, over-temperature detection), thus reducing pin count. Over-temperature detection will work on-the-run, whereas the open- and shorted-LED detection can be used on-the-run or in low-current diagnostic mode (see page 15).

Figure 7. AS1113 - Block Diagram



## Serial Interface

Data accesses are made serially via pins SDI and SDO. At each CLK rising edge, the signal present at pin SDI is shifted into the first bit of the internal shift register and the other bits are shifted ahead of the first bit. The MSB is the first bit to be clocked in. In error-detection mode the shift register will latch-in the corresponding error data of temperature-, open-, and short-error register with each falling edge of LD.

The 16-bit data register will latch the data of the shift register at each rising edge of LD. This data is then used to drive the current generator output drivers to switch on the corresponding LEDs as OEN goes low.

## Timing Diagrams

This section contains timing diagrams referenced in other sections of this data sheet.

Figure 8. Normal Mode Timing Diagram

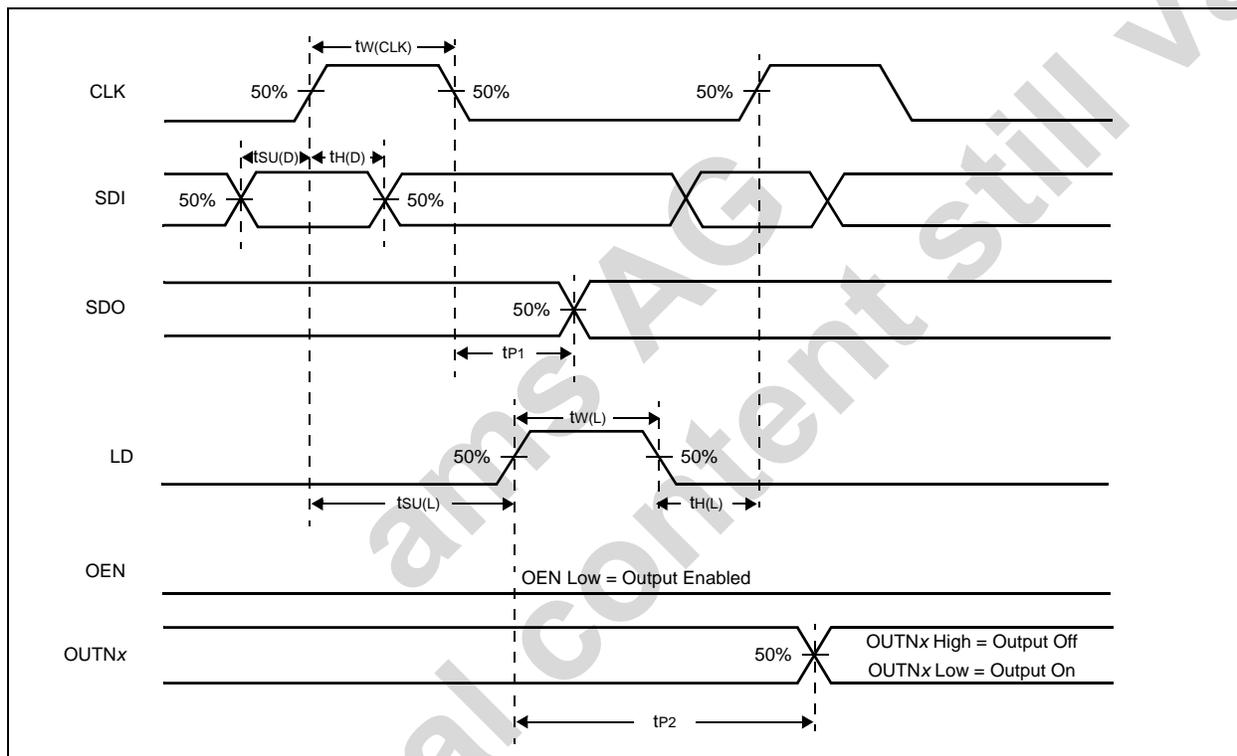


Figure 9. Output Delay Timing Diagram

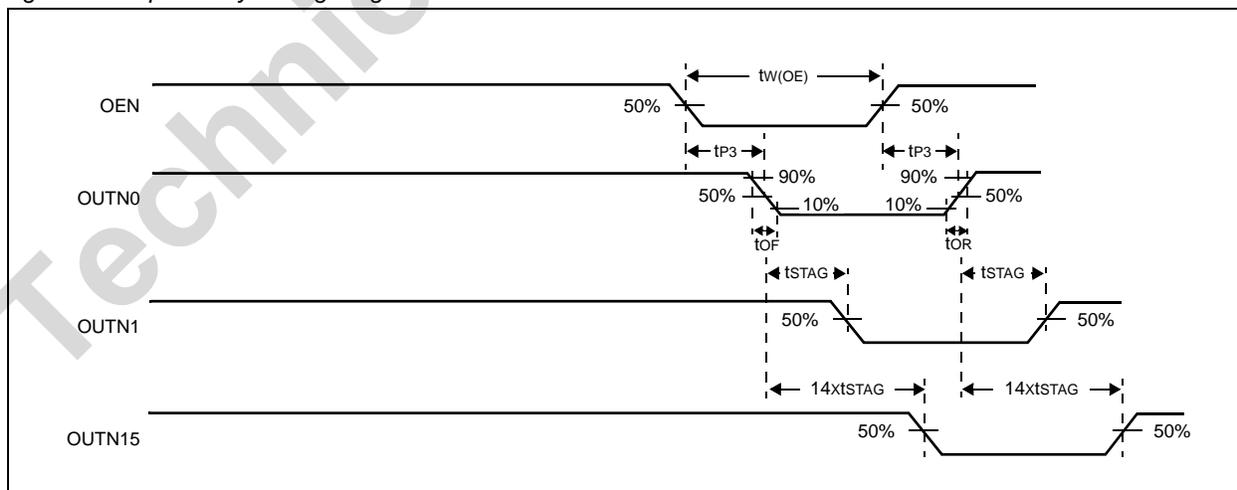


Figure 10. Data Input Timing Diagram

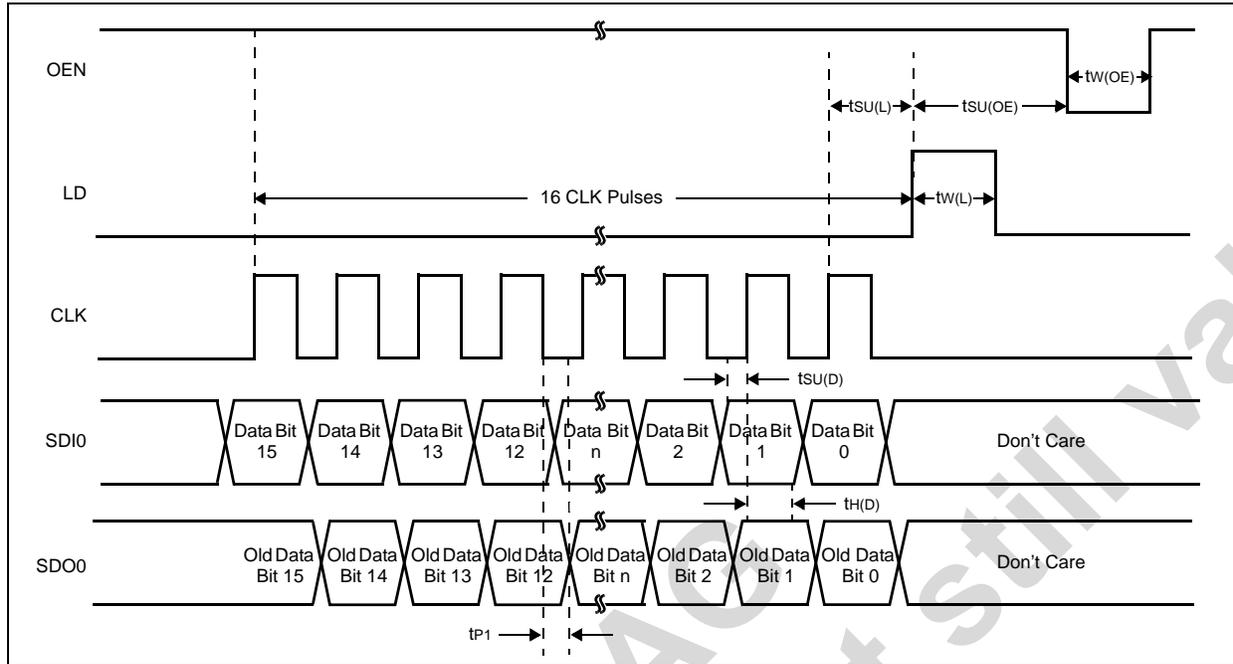


Figure 11. Data Input Example Timing Diagram

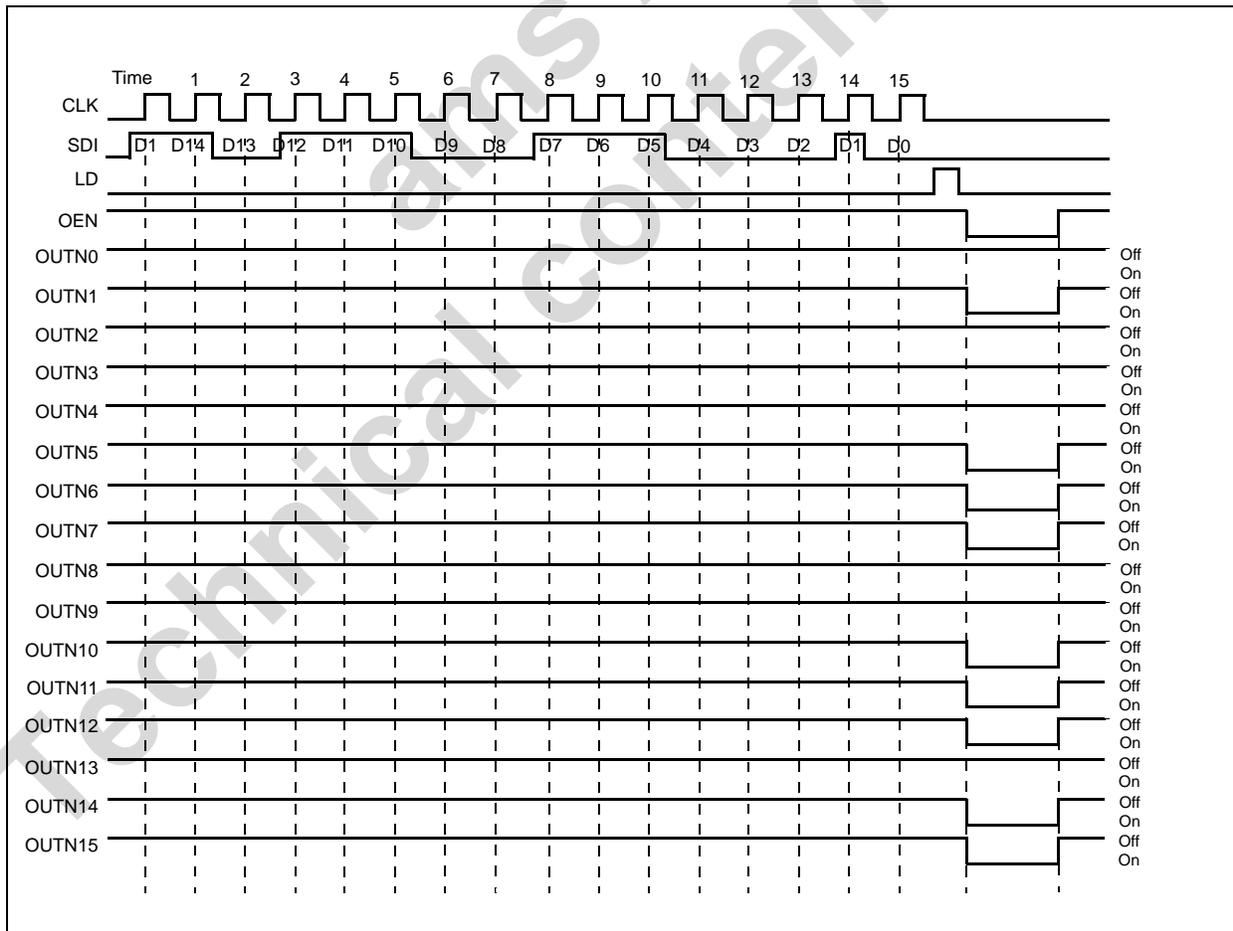
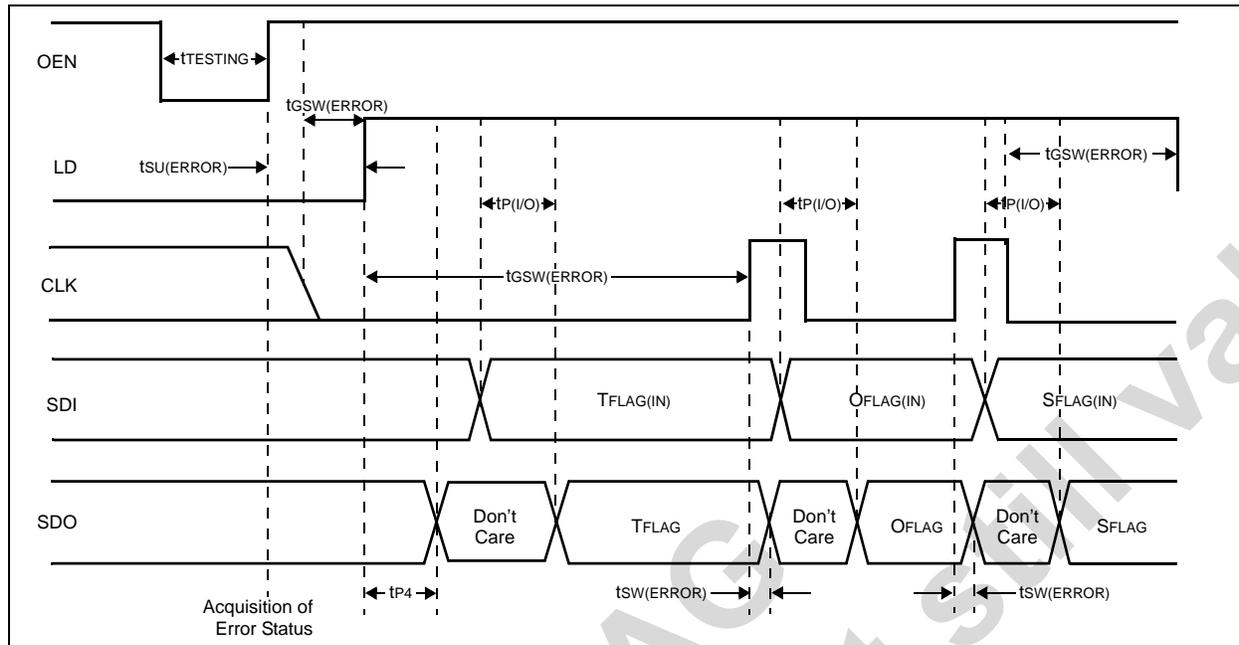


Figure 12. Switching Global Error Mode Timing Diagram



## Error-Detection Mode

Acquisition of the error status occurs at the rising edge of OEN. Error-detection mode is started on the rising edge of LD when OEN is high. The CLK signal must be low when entering error detection mode. Error detection for open- and shorted-LEDs can only be performed for LEDs that are switched on during test time. To switch between error-detection modes clock pulses are needed (see Table 5).

**Note:** To test all LEDs, a test pattern that turns on all LEDs must be input to the AS1113.

## Global Error Mode

Global error mode is entered when error-detection mode is started. Clock pulses during this period are used to select between temperature, open-LED, and shorted-LED tests, as well as low-current diagnostic mode and shutdown mode (see Table 5). In global error mode, an error flag (TFLAG, OFLAG, SFLAG) is delivered to pin SDO if any errors are encountered.

Table 5. Global Error Mode Selections

Clock Pulses	Output Port	Error-Detection Mode	Global Error Flag/Shutdown Condition
0	Don't Care	Over-Temperature Detection	TFLAG = SDO = 1: No over-temperature warning. TFLAG = SDO = 0: Over-temperature warning.
1	Enabled	Open-LED Detection	OFLAG = SDO = 1: No open-LED error. OFLAG = SDO = 0: Open-LED error.
2	Enabled	Shorted-LED Detection	SFLAG = SDO = 1: No shorted-LED error. SFLAG = SDO = 0: Shorted-LED error.
3	Don't Care	Low-Current Diagnostic Mode	
4	Don't Care	Shutdown Mode	SDI = 1: Wakeup SDI = 0: Shutdown

**Note:** For a valid result SDI must be 1 for the first device.

If there are multiple AS1113s in a chain, the error flag will be gated through all devices. To get a valid result at the end of the chain, a logic 1 must be applied to the SDI input of the first device of the chain. If one device produces an error this error will show up after  $n \cdot t_{P(I/O)} + t_{SW(ERROR)}$  at pin SDO of the last device in the chain. This means it is not possible to identify which device in the chain produced the error. Therefore, if a global error occurs, the detailed error report can be run to identify which AS1113, or LED produced the error.

**Note:** When no error has occurred, the detailed error report can be skipped, setting LD and subsequently OEN low.

## Error Detection Functions

### Open-LED Detection

The AS1113 open-LED detection is based on the comparison between  $V_{DS}$  and  $V_{THL}$ . The open LED status is acquired at the rising edge of OEN and stored internally. While detecting open-LEDs the output port must be turned on. Open LED detection can be started with 1 clock pulse during error detection mode while the output port is turned on.

**Note:** LEDs which are turned off at test time cannot be tested and will be shown as a logic 1 in the detailed error report.

Table 6. Open LED Detection Modes

Output Port State	Effective Output Point Conditions	Detected Open-LED Error Status Code	Meaning
On	$V_{DS} < V_{THL}$	0	Open Circuit
On	$V_{DS} > V_{THL}$	1	Normal

### Shorted-LED

The AS1113 shorted-LED detection is based on the comparison between  $V_{DS}$  and  $V_{THH}$ . The shortened LED status is acquired at the rising edge of OEN and stored internally. While detecting shorted-LEDs the output port must be turned on. Shorted-LED detection can be started with 2 clock pulses during error detection mode while the output port is turned on.

For valid results, the voltage at OUTN0:OUTN15 must be lower than  $V_{THH}$  under low-current diagnostic mode operating conditions. This can be achieved by reducing the  $V_{LED}$  voltage or by adding additional diodes, resistors or LED's.

**Note:** LEDs which are turned off at test time cannot be tested and will be shown as a logic 1 in the detailed error report.

Table 7. Shorted LED Detection Modes

Output Port State	Effective Output Point Conditions	Detected Shorted-LED Error Status Code	Meaning
On	$V_{DS} > V_{THH}$	0	Short Circuit
On	$V_{DS} < V_{THH}$	1	Normal

### Overtemperature

Thermal protection for the AS1113 is provided by continuously monitoring the device's core temperature. The overtemperature status is acquired at the rising edge of OEN and stored internally.

Table 8. Overtemperature Modes

Output Port State	Effective Output Point Conditions	Detected Overtemperature Status Code	Meaning
Don't Care	Temperature > $T_{OV1}$	0	Overtemperature Condition
Don't Care	Temperature < $T_{OV1}$	1	Normal

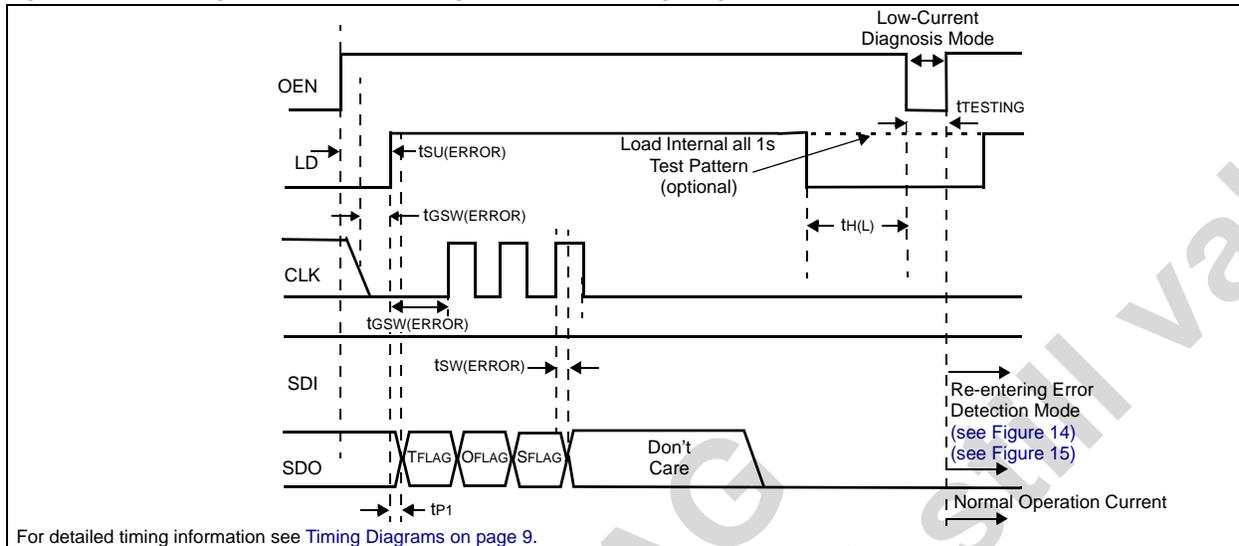






On the next falling edge of OEN, current is reduced to  $I_{LC}$ . With the next rising edge of OEN the current will immediately increase to normal levels and the detailed error report can be read out entering error-detection mode.

Figure 16. Switching into Low-Current Diagnostic Mode Timing Diagram



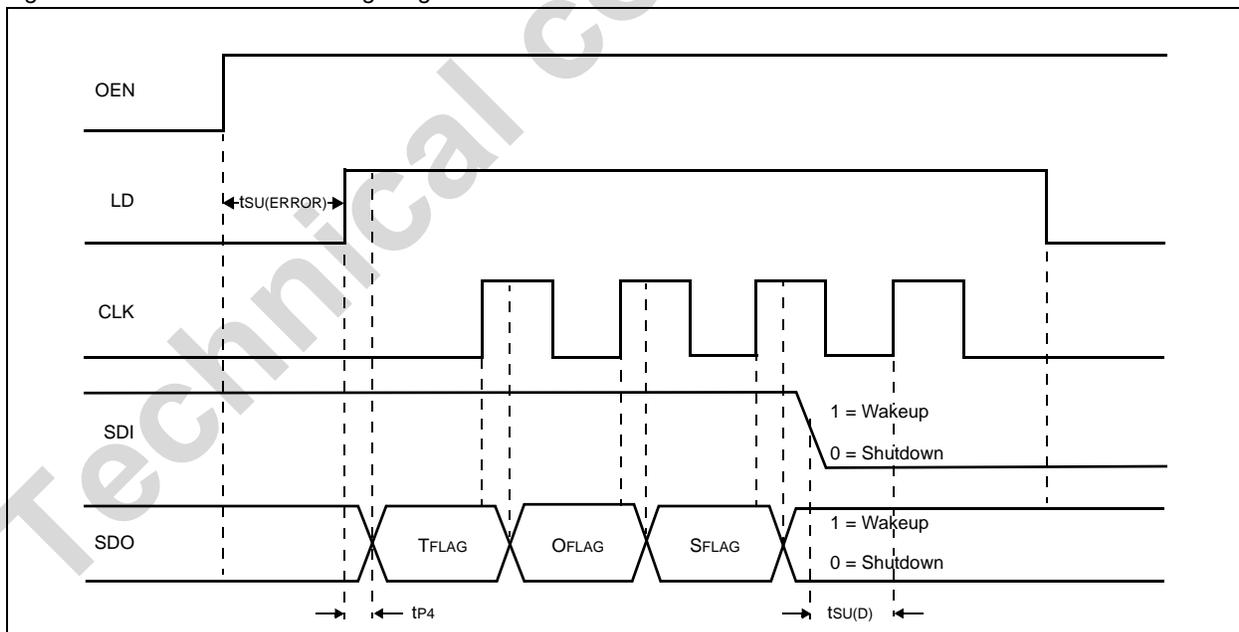
## Shutdown Mode

The AS1113 features a shutdown mode which can be entered via 4 clock pulses during error-detection mode. To enable the shutdown mode a 0 must be placed at SDI after the rising edge of the 3rd clock pulse.

To disable shutdown mode a 1 must be placed at SDI after the 3rd clock pulse. The shutdown/wakeup information will be latched through if multiple AS1113 devices are in a chain. At the rising edge of the 4th clock pulse the shutdown bit will be read out and the AS1113 will shutdown or wakeup.

**Note:** In shutdown mode the supply current drops down to  $<10\mu\text{A}$ .

Figure 17. Shutdown Mode Timing Diagram



## 9 Application Information

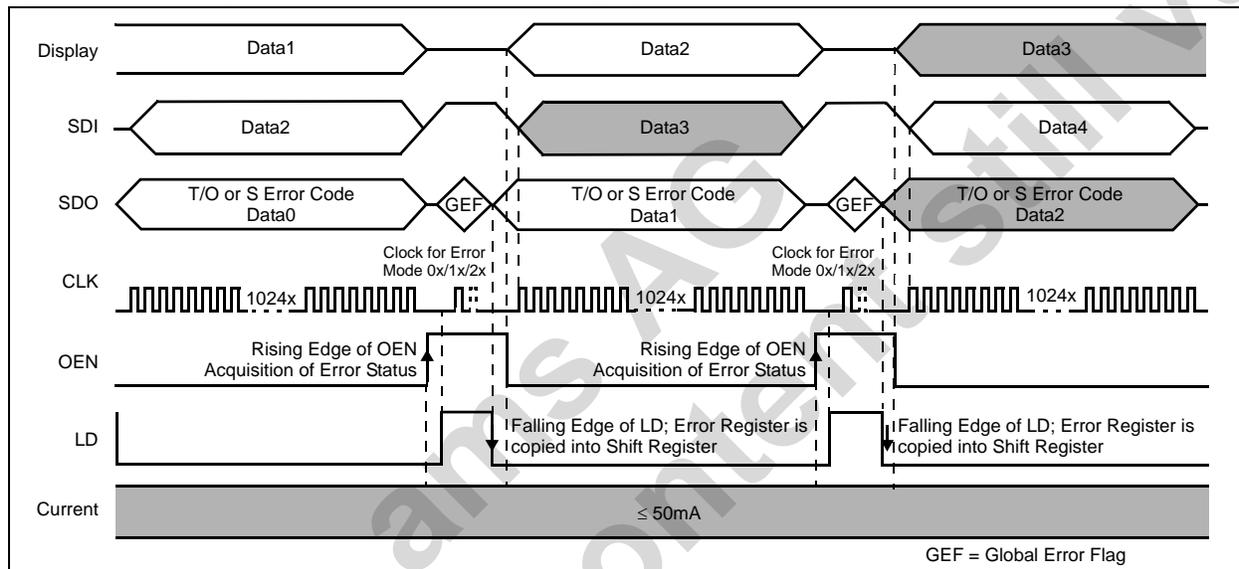
### Error Detection

The AS1113 features two types of error detection. The error detection can be used on-the-fly, for active LEDs, without any delay, or by entering into low-current diagnosis mode.

#### Error Detection On-The-Fly

Error detection on-the-fly will output the status of active LEDs during operation. Without choosing an error mode this will output the temperature flag at every input/output cycle. Triggering one clock pulse for open or two clock pulses for short detection during error detection mode outputs the detailed open- or short-error report with the next input/output cycle (see Figure 18). LEDs turned off at test time are not tested and will show a logic "1" at the detailed error report.

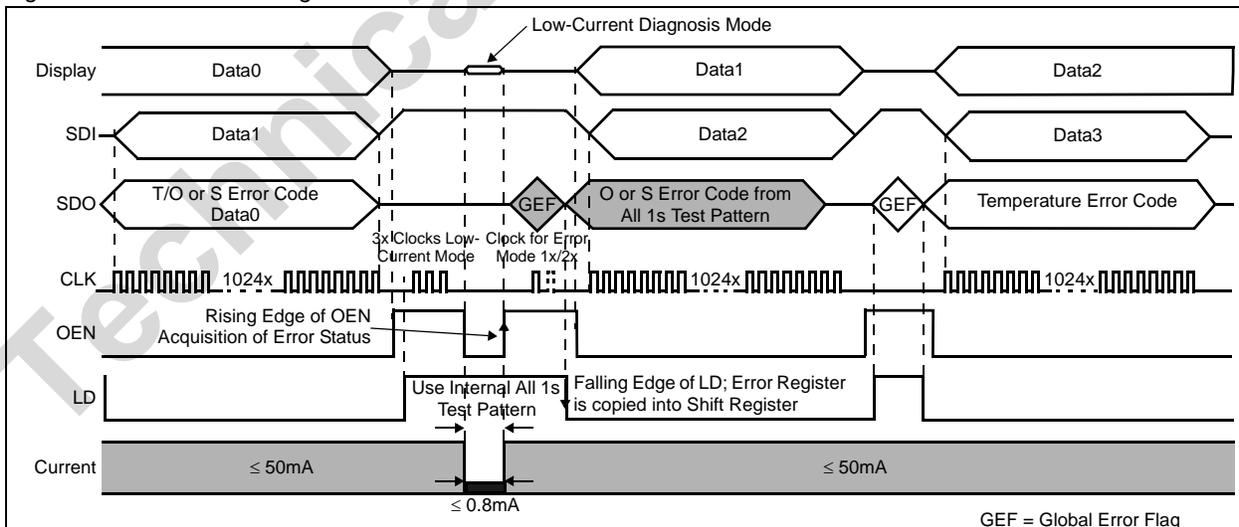
Figure 18. Normal Operation with Error Detection During Operation – 64 Cascaded AS1113s



#### Error Detection with Low-Current Diagnosis Mode

This unique feature of the AS1113 uses an internal all 1s test pattern for a flicker free diagnosis of all LEDs. This error detection mode can be started at the end of each input cycle (see Figure 19).

Figure 19. Low-Current Diagnosis Mode with Internal All 1s Test Pattern – 64 Cascaded AS1113s



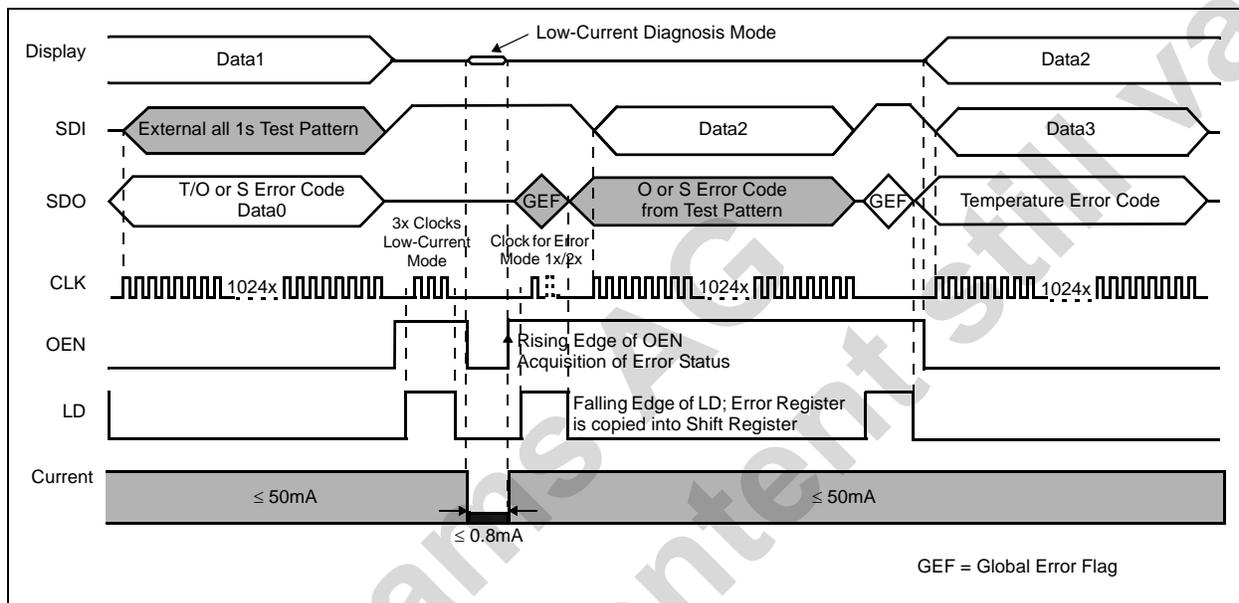
The last pattern written into the shift register will be saved before starting low-current diagnosis mode and can be displayed immediately after the test has been performed.

Low-current diagnostic mode is started with 3 clock pulses during error detection mode. Then OEN should be enabled for  $\geq 2\mu\text{s}$  for testing. With the rising edge of OEN the LED test is stopped, and while LD is high the desired error mode can be selected with the corresponding clock pulses. After LD and OEN go low again the previously saved pattern can be displayed at the outputs.

With the next data input the detailed error code will be clocked out at pin SDO.

**Note:** See Figure 20 for use of an external test pattern.

Figure 20. Low-Current Diagnosis Mode with External Test Pattern – 64 Cascaded AS1113s

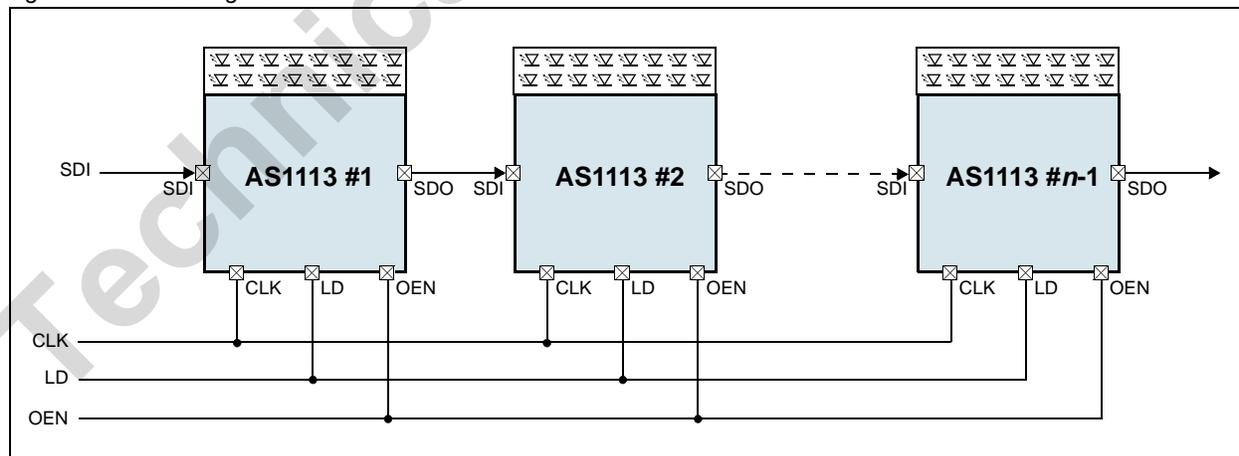


## Cascading Devices

To cascade multiple AS1113 devices, pin SDO must be connected to pin SDI of the next AS1113 (see Figure 21). At each rising edge of CLK the LSB of the shift register will be written into the shift register SDI of the next AS1113 in the chain.

**Note:** When  $n$  AS1113 devices are in one chain,  $n \cdot 16$  clock pulses are needed to latch-in the input data.

Figure 21. Cascading AS1113 Devices



## Constant Current

In LED display applications, the AS1113 provides virtually no current variations from channel-to-channel and from AS1113-to-AS1113. This is mostly due to 2 factors:

- While  $I_{OUT} \geq 10\text{mA}$ , the maximum current skew is less than  $\pm 3\%$  between channels and less than  $\pm 6\%$  between AS1113 devices.
- In the saturation region, the characteristic curve of the output stage is flat (see Figure 5 on page 7). Thus, the output current can be kept constant regardless of the variations of LED forward voltages ( $V_F$ ).

## Adjusting Output Current

The AS1113 scales up the reference current ( $I_{REF}$ ) set by external resistor ( $R_{EXT}$ ) to sink a current ( $I_{OUT}$ ) at each output port. As shown in Figure 3 on page 7 the output current in the saturation region is extremely flat so that it is possible to define it as target current ( $I_{OUT\ TARGET}$ ).  $I_{OUT\ TARGET}$  can be calculated by:

$$V_{REXT} = 1.253\text{V} \quad (\text{EQ 1})$$

$$I_{REF} = V_{REXT}/R_{EXT} \text{ (if the other end of } R_{EXT} \text{ is connected to ground)} \quad (\text{EQ 2})$$

$$I_{OUT\ TARGET} = I_{REF} * 15 = (1.253\text{V}/R_{EXT}) * 15 \quad (\text{EQ 3})$$

### Where:

$R_{EXT}$  is the resistance of the external resistor connected to pin  $R_{EXT}$ .

$V_{REXT}$  is the voltage on pin  $R_{EXT}$ .

The magnitude of current (as a function of  $R_{EXT}$ ) is around 50.52mA at 372 $\Omega$  and 25.26mA at 744 $\Omega$ . Figure 3 on page 7 shows the relationship curve between the  $I_{OUT\ TARGET}$  of each channel and the corresponding external resistor ( $R_{EXT}$ ).

## Package Power Dissipation

The maximum allowable package power dissipation ( $P_D$ ) is determined as:

$$P_{D(MAX)} = (T_J - T_{AMB})/R_{TH(J-A)} \quad (\text{EQ 4})$$

When 16 output channels are turned on simultaneously, the actual package power dissipation is:

$$P_{D(ACT)} = (I_{DD} * V_{DD}) + (I_{OUT} * \text{Duty} * V_{DS} * 16) \quad (\text{EQ 5})$$

Therefore, to keep  $P_{D(ACT)} \leq P_{D(MAX)}$ , the maximum allowed output current as a function of duty cycle is:

$$I_{OUT} = \{[(T_J - T_{AMB})/R_{TH(J-A)}] - (I_{DD} * V_{DD})\} / V_{DS} / \text{Duty} / 16 \quad (\text{EQ 6})$$

### Where:

$T_J = 150^\circ\text{C}$

## Delayed Outputs

The AS1113 has graduated delay circuits between outputs. These delay circuits can be found between  $OUTN_n$  and constant current block.

The fixed delay time is 20 ns (typ) where  $OUTN_0$  has no delay,  $OUTN_1$  has 20ns delay,  $OUTN_2$  has 40ns delay ...  $OUTN_{15}$  has 300ns delay. This delay prevents large inrush currents, which reduce power supply bypass capacitor requirements when the outputs turn on (see Figure 10 on page 10)

## Switching-Noise Reduction

LED drivers are frequently used in switch-mode applications which normally exhibit switching noise due to parasitic inductance on the PCB.

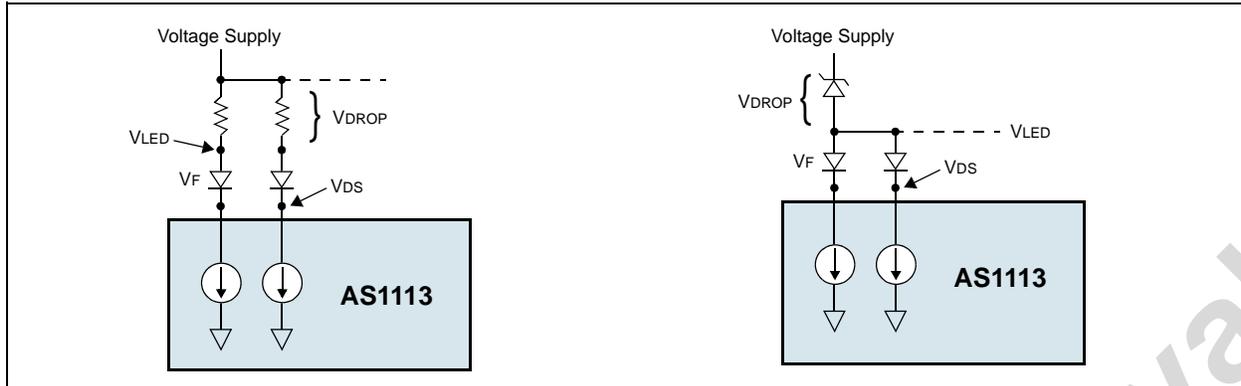
## Load Supply Voltage

Considering the package power dissipation limits (see EQ 4:6), the AS1113 should be operated within the range of  $V_{DS} = 0.4$  to 1.0V.

For example, if  $V_{LED}$  is higher than 5V,  $V_{DS}$  may be so high that  $P_{D(ACT)} > P_{D(MAX)}$  where  $V_{DS} = V_{LED} - V_F$ . In this case, the lowest possible supply voltage or a voltage reducer ( $V_{DROP}$ ) should be used. The voltage reducer allows  $V_{DS} = (V_{LED} - V_F) - V_{DROP}$ .

**Note:** Resistors or zener diodes can be used as a voltage reducer as shown in Figure 22.

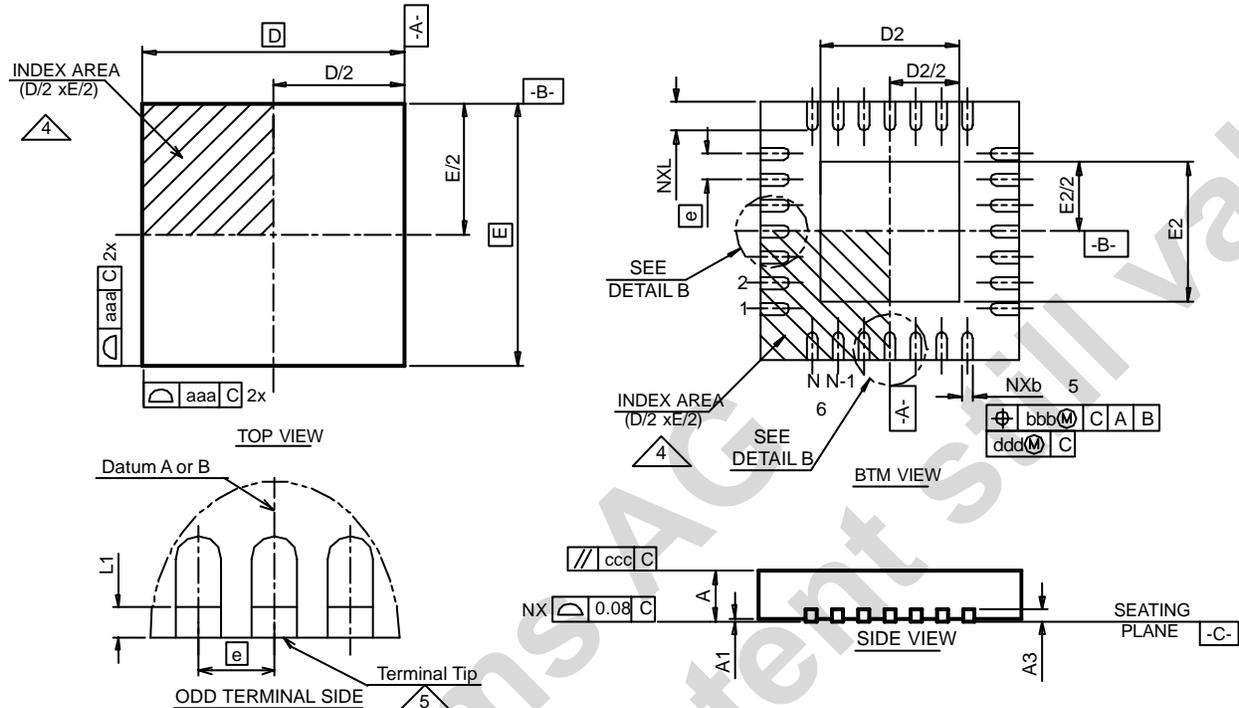
Figure 22. Voltage Reducer using Resistor (Left) and Zener Diode (Right)



## 10 Package Drawings and Markings

The AS1113 is available in a 28-pin QFN (5x5mm) package and a 24-pin SSOP package.

Figure 23. 28-pin QFN (5x5mm) Package



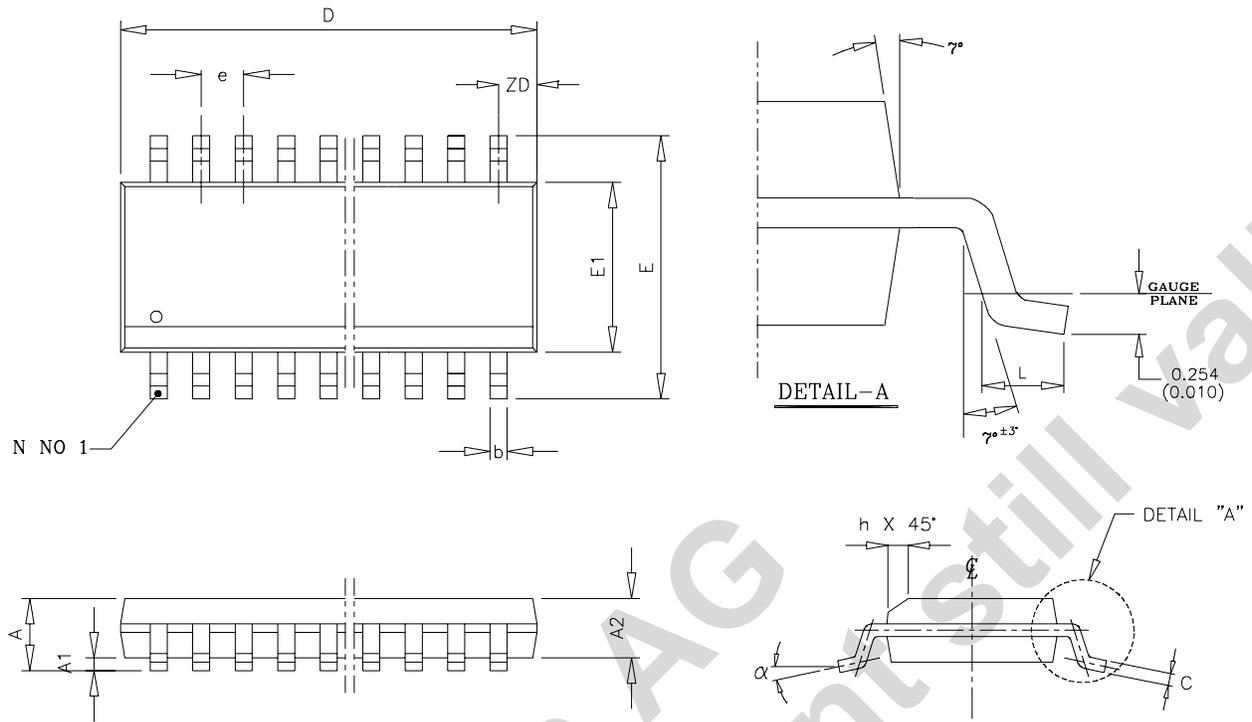
Symbol	Min	Typ	Max	Notes
A	0.70	0.75	0.80	1, 2
A1	0.00	0.02	0.05	1, 2
A3		0.20 REF		1, 2
L	0.45	0.55	0.65	1, 2
L1	0.03		0.15	1, 2
aaa		0.15		1, 2
bbb		0.10		1, 2
ccc		0.10		1, 2
ddd		0.05		1, 2
eee		0.08		1, 2
ggg		0.10		1, 2

Symbol	Min	Typ	Max	Notes
D BSC		5.00		1, 2
E BSC		5.00		1, 2
D2	3.00	3.15	3.25	1, 2
E2	3.00	3.15	3.25	1, 2
K	0.20			1, 2
b	0.18	0.25	0.30	1, 2, 5
e		0.50		
N		28		1, 2
ND		7		1, 2, 5
NE		7		1, 2, 5

**Notes:** Unilateral coplanarity zone applies to the exposed heat sink slug as well as the terminals.

1. Dimensioning and tolerancing conform to *ASME Y14.5M-1994*.
2. All dimensions are in millimeters; angles in degrees.
3. N is the total number of terminals.
4. The terminal #1 identifier and terminal numbering convention shall conform to *JEDEC 95 SPP-012*. Details of terminal #1 identifier are optional but must be located within the zone indicated. The terminal #1 identifier may be either a mold or marked feature.
5. Dimension b applies to metallized terminal and is measured between 0.15 and 0.30mm from terminal tip. If one end of the terminal has the optional radius, the b dimension should not be measured in that radius area.
6. Dimensions ND and NE refer to the number of terminals on each D and E side, respectively.

Figure 24. 24-pin SSOP Package



Symbol	Min	Max
A	1.35	1.75
A1	0.10	0.25
A2	1.37	1.57
b	0.20	0.30
C	0.19	0.25
D	8.55	8.74
E	5.79	6.20
E1	3.81	3.99
e	0.635 BSC	
h	0.22	0.49
L	0.40	1.27
$\theta$	0°	8°

## 11 Ordering Information

The device is available as the standard products shown in [Table 9](#).

Table 9. Ordering Information

Ordering Code	Description	Delivery Form	Package
AS1113-BSSU	50mA, 16-Channel LED Driver with Diagnostics	Tubes	24-pin SSOP
AS1113-BSST	50mA, 16-Channel LED Driver with Diagnostics	Tape and Reel	24-pin SSOP
AS1113-BQFR	50mA, 16-Channel LED Driver with Diagnostics	Tray	28-pin QFN (5x5mm)
AS1113-BQFT	50mA, 16-Channel LED Driver with Diagnostics	Tape and Reel	28-pin QFN (5x5mm)

**Note:** All products are RoHS compliant and Pb-free.

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